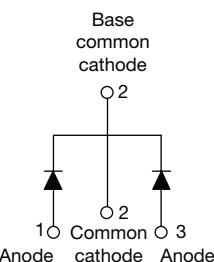
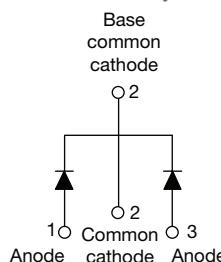


## Schottky Rectifier, 2 x 20 A

**VS-40CTQ045SPbF**

**D<sup>2</sup>PAK**
**VS-40CTQ045-1PbF**

**TO-262**

### FEATURES

- 150 °C T<sub>J</sub> operation
- Center tap configuration
- Very low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified


**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### DESCRIPTION

This center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### PRODUCT SUMMARY

I <sub>F(AV)</sub>	2 x 20 A
V <sub>R</sub>	45 V

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I <sub>F(AV)</sub>	Rectangular waveform	40	A
V <sub>RRM</sub>		45	V
I <sub>FSM</sub>	t <sub>p</sub> = 5 µs sine	1240	A
V <sub>F</sub>	20 Apk, T <sub>J</sub> = 125 °C (per leg)	0.48	V
T <sub>J</sub>	Range	- 55 to 150	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-40CTQ045SPbF VS-40CTQ045-1PbF	UNITS
Maximum DC reverse voltage	V <sub>R</sub>		
Maximum working peak reverse voltage	V <sub>RWM</sub>	45	V

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current per leg See fig. 5	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>C</sub> = 116 °C, rectangular waveform	20	A
per device			40	
Maximum peak one cycle non-repetitive surge current per leg See fig. 7	I <sub>FSM</sub>	5 µs sine or 3 µs rect. pulse	1240	
		10 ms sine or 6 ms rect. pulse	350	
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 3 A, L = 4.40 mH	20	mJ
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zero in 1 µs Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical	3	A

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum forward voltage drop per leg See fig. 1	$V_{FM}^{(1)}$	20 A	$T_J = 25 \text{ }^\circ\text{C}$	0.53	V	
		40 A		0.68		
		20 A	$T_J = 125 \text{ }^\circ\text{C}$	0.48		
		40 A		0.67		
Maximum reverse leakage current per leg See fig. 2	$I_{RM}^{(1)}$	$T_J = 25 \text{ }^\circ\text{C}$	$V_R = \text{Rated } V_R$	3	mA	
		$T_J = 125 \text{ }^\circ\text{C}$		115		
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$		0.27	V	
Forward slope resistance	$r_t$			8.72	$\text{m}\Omega$	
Maximum junction capacitance per leg	$C_T$	$V_R = 5 \text{ V}_{\text{DC}}$ (test signal range 100 kHz to 1 MHz), $25 \text{ }^\circ\text{C}$		2800	pF	
Typical series inductance per leg	$L_S$	Measured lead to lead 5 mm from package body		8.0	nH	
Maximum voltage rate of change	$dV/dt$	Rated $V_R$		10 000	$\text{V}/\mu\text{s}$	

**Note**(1) Pulse width < 300  $\mu\text{s}$ , duty cycle < 2 %
**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum junction and storage temperature range	$T_J, T_{Stg}$			- 55 to 150	$^\circ\text{C}$	
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		2.0	$^\circ\text{C}/\text{W}$	
Maximum thermal resistance, junction to case per package				1.0		
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased		0.50		
Approximate weight				2	g	
				0.07	oz.	
Mounting torque	minimum			6 (5)	$\text{kgf} \cdot \text{cm}$ (lbf · in)	
	maximum			12 (10)		
Marking device		Case style D <sup>2</sup> PAK		40CTQ045S		
		Case style TO-262		40CTQ045-1		

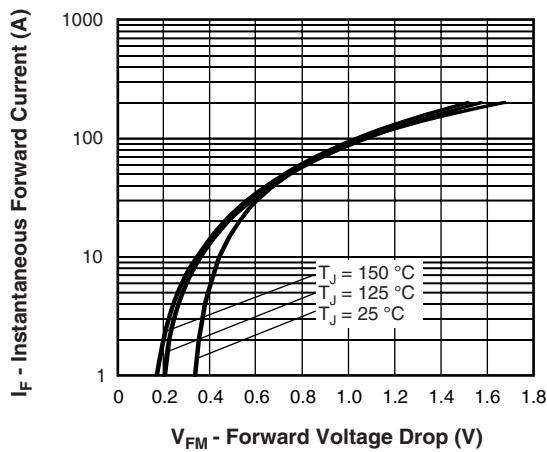


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

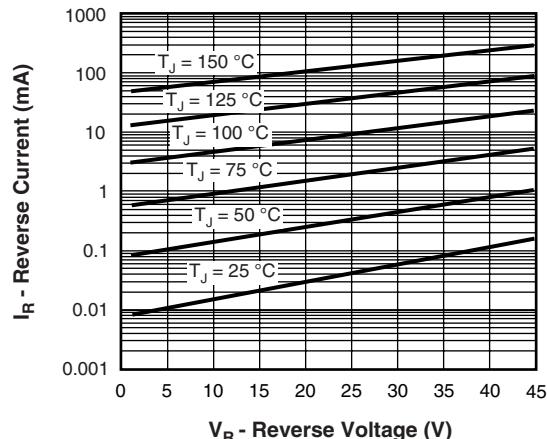


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

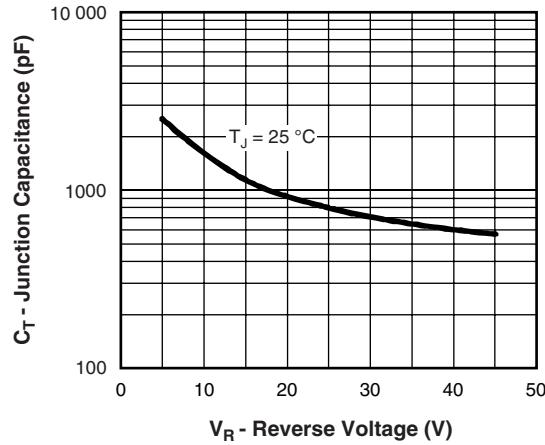


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

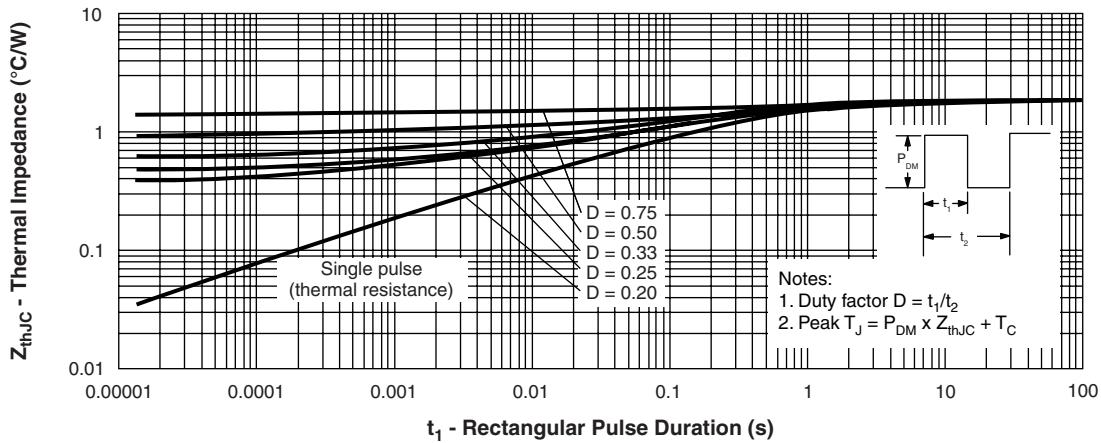


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

# VS-40CTQ045SPbF, VS-40CTQ045-1PbF



Vishay High Power Products Schottky Rectifier, 2 x 20 A

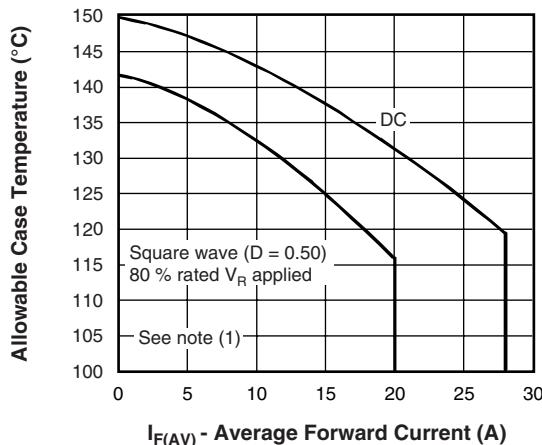


Fig. 5 - Maximum Allowable Case Temperature vs.  
Average Forward Current (Per Leg)

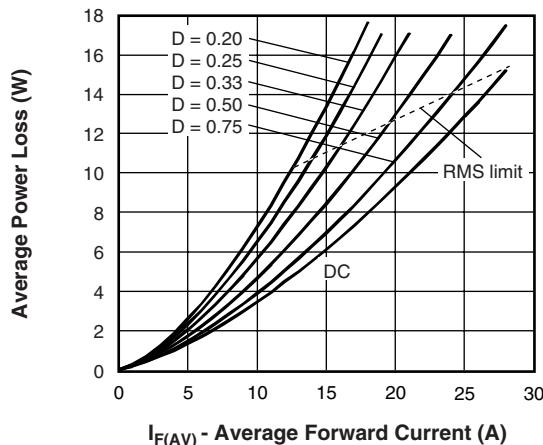


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

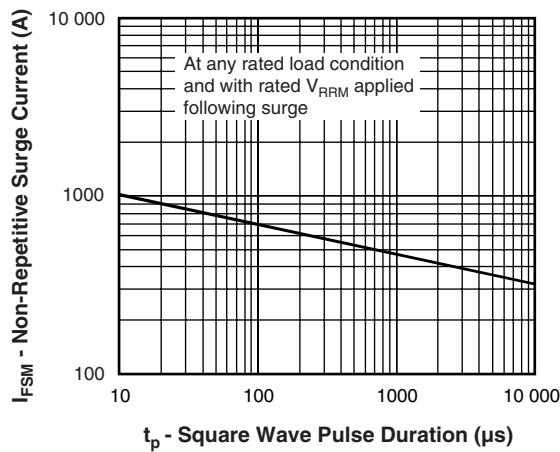


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

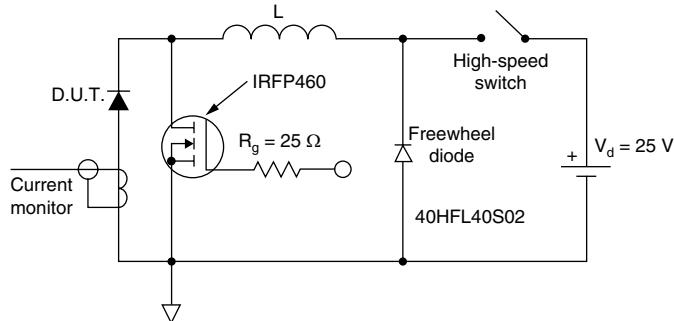


Fig. 8 - Unclamped Inductive Test Circuit

## Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}$ ;  
 $P_{dREV} = \text{Inverse power loss} = V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1} = 10$  V

### ORDERING INFORMATION TABLE

Device code	VS-	40	C	T	Q	045	S	TRL	PbF
	(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)

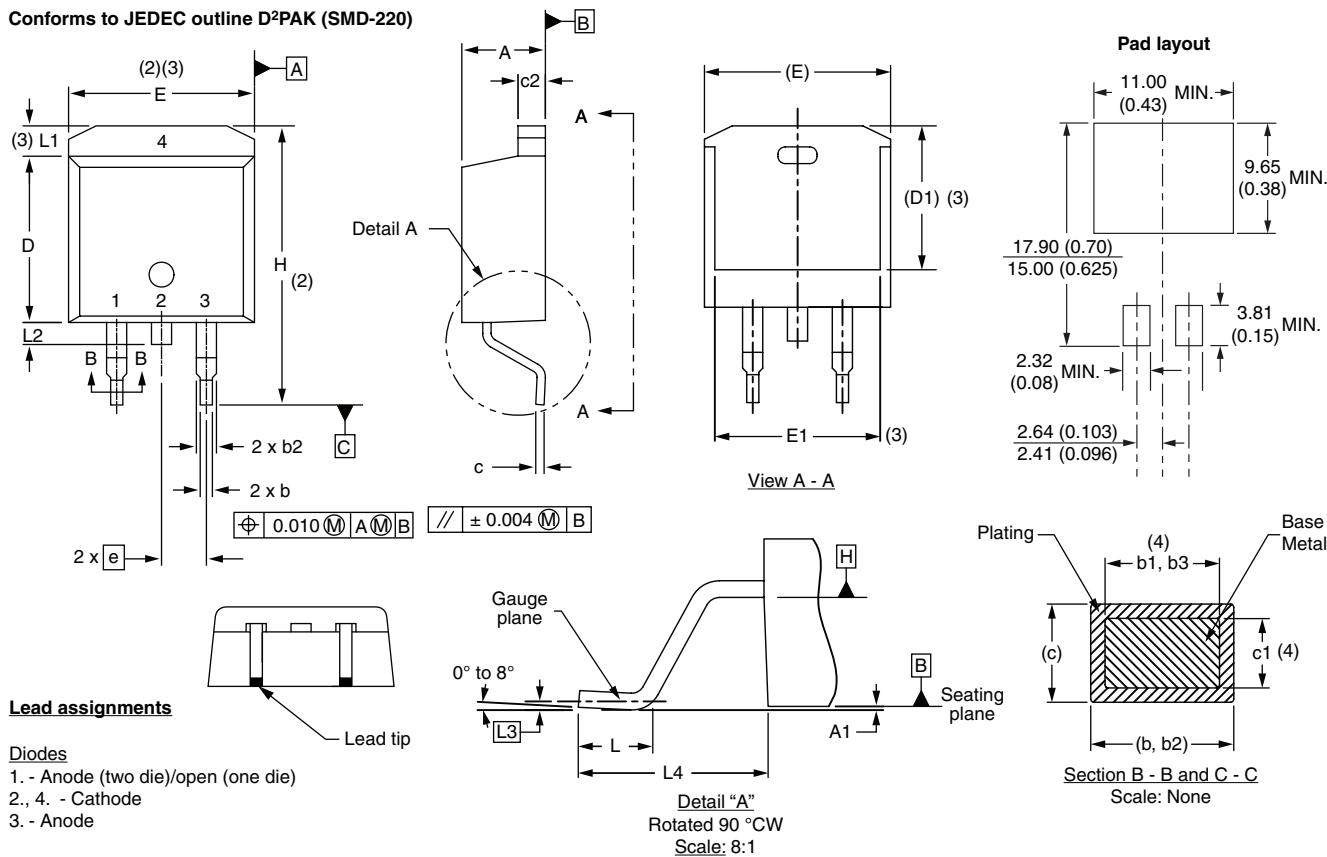
- 1** - HPP product suffix
- 2** - Current rating (40 A)
- 3** - Circuit configuration: C = Common cathode
- 4** - T = TO-220
- 5** - Schottky "Q" series
- 6** - Voltage rating (045 = 45 V)
- 7** - • S = D<sup>2</sup>PAK  
• -1 = TO-262
- 8** - • None = Tube (50 pieces)  
• TRL = Tape and reel (left oriented - for D<sup>2</sup>PAK only)  
• TRR = Tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** - PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95014">www.vishay.com/doc?95014</a>
Part marking information	<a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a>
Packaging information	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

### D<sup>2</sup>PAK, TO-262

#### DIMENSIONS FOR D<sup>2</sup>PAK in millimeters and inches

Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.				MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		e	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070			H	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
c	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

(7) Outline conforms to JEDEC outline TO-263AB

# Outline Dimensions

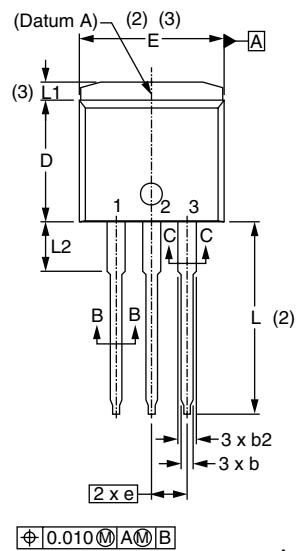
Vishay High Power Products

D<sup>2</sup>PAK, TO-262

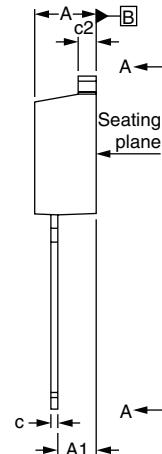


## DIMENSIONS FOR TO-262 in millimeters and inches

Modified JEDEC outline TO-262



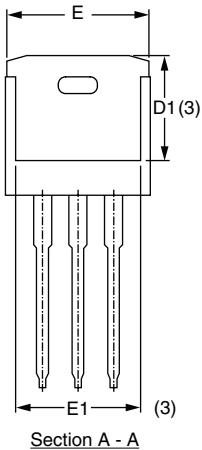
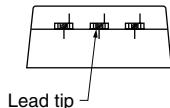
$\pm 0.010$  M A M B



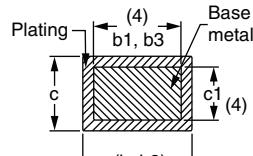
### Lead assignments

#### Diodes

1. - Anode (two die)/open (one die)
- 2., 4. - Cathode
3. - Anode



Section A - A



Section B - B and C - C

Scale: None

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## Material Category Policy

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**